

Batch Production of Wafer-Scale Monolayer MoS₂

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(1) Experimental setup

Batch production of monolayer MoS₂ wafers were grown by CVD and Figure S1 presents the photograph for the experimental setup. The CVD system consists of a three-temperature-zone tube furnace, a vacuum chamber and the gas circuit. Sulfur powder and molybdenum trioxide powder were employed as precursors and were loaded in a quartz boat and an inner quartz tube at low temperature zone I and zone II, respectively. 1-inch wafer-scale sapphire substrates were stuck in the grooves of the tailor-made sample holder erected and were placed in high temperature zone III. Monolayer MoS₂ wafers were produced in batch in this CVD system under proper temperature and flow rates. Actually, batch production of oxygen doped MoS₂ wafers were also synthesized in this system and the growth parameters were adjusted slightly compared with those for intrinsic MoS₂ wafers.

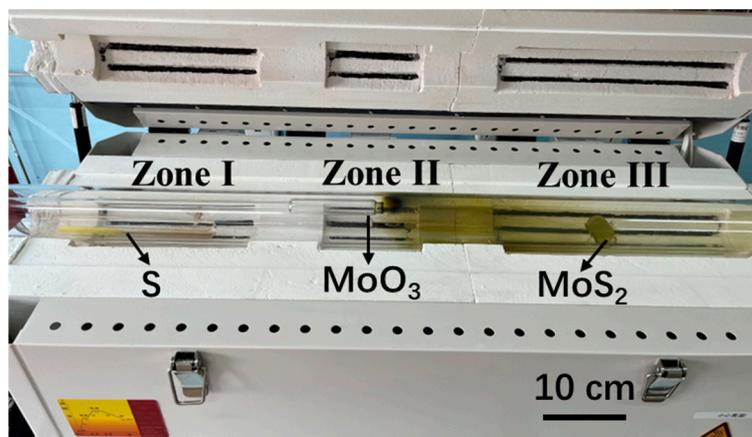


Figure S1. Experimental setup for batch production.

(2) Optical microscopy images

Optical microscopy images of the four monolayer MoS₂ wafers from one batch are shown in Figure S2 and a-d are images for wafer numbered 1-4, respectively. All of the optical microscopy images exhibit clean surfaces and similar contrasts, indicating the great cleanliness and homogeneity for the wafers in the same batch. Note that the scratches on the surface of samples are made by tweezers artificially for the comparison of MoS₂ monolayers and sapphire substrates.



Figure S2. Optical microscopy images of MoS₂ monolayers in one batch. (a–d) Optical microscopy images for wafer 1 - wafer 4. Scale bars: 20 μm.

(3) AFM of sapphire

As depicted in Figure S3, the AFM image demonstrates that the sapphire substrate exhibits smooth morphology with steps on the surface. Through analysis of the AFM image, the roughness of the sapphire substrates is calculated to be 0.2 nm. These substrate steps play a pivotal role in facilitating the nucleation process during the monolayer MoS₂ growth.

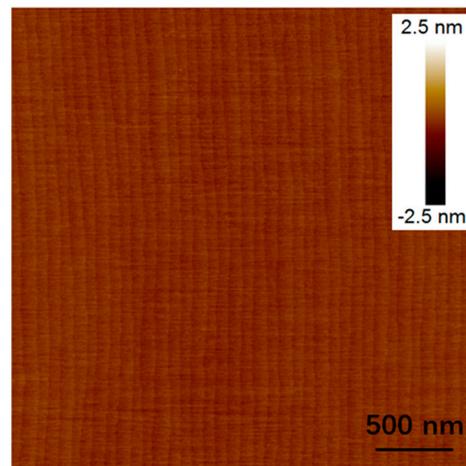


Figure S3. AFM image of sapphire substrate. Inset shows the color-scale of height.

(4) Thickness of MoS₂

The layer number of MoS₂ samples is characterized by AFM. Figure S4 demonstrates the AFM image of MoS₂ ribbon on sapphire substrate. The measured height at the ribbon's edge is approximately 0.6 nm, consistent with the thickness of a monolayer MoS₂ film.

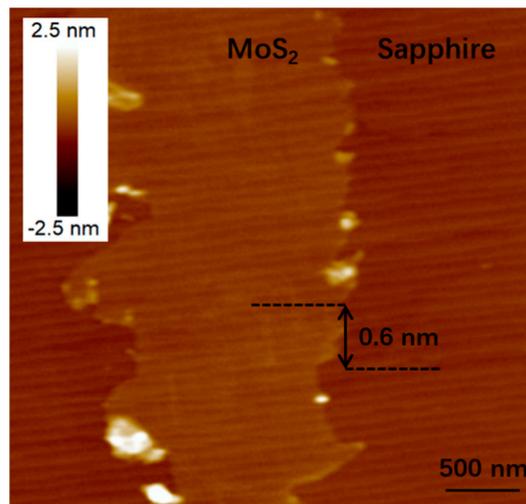


Figure S4. AFM image of the MoS₂ ribbon on sapphire substrate. Inset is the color-scale bar.

(5) Grain size of monolayer MoS₂

We have estimated the grain size of MoS₂ monolayer by AFM. In order to figure out the location and shape of grain boundaries, we fumigated the sample with steam. Figure S5 shows the AFM image of the MoS₂ sample with clear grain boundaries and the grain size of MoS₂ is measured around 1 μm .

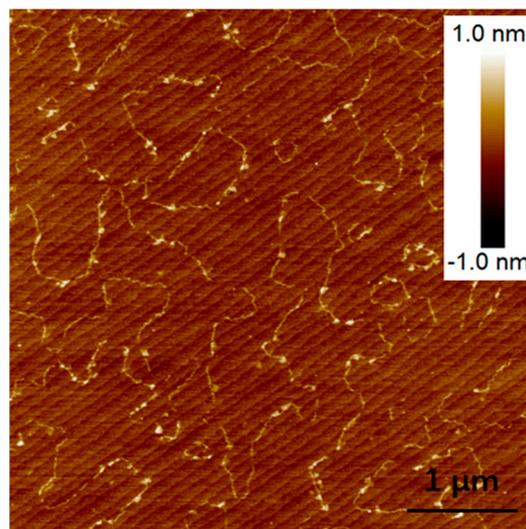


Figure S5. Estimate of the crystal grain size of MoS₂ by AFM image. Inset shows the color-scale of height.

(6) Raman spectra

To investigate the homogeneity of the batch-produced MoS₂ monolayers across the entire wafer scale, we conducted optical spectroscopy. The normalized raw data of the Raman spectra for MoS₂ monolayers along the X-direction and Y-direction are presented in Figure S6a and S6b, respectively. The spectra show typical E_{2g} and A_{1g} Raman peaks and all of the Raman peaks exhibit coincident peak position and uniform intensity in both directions, indicating the excellent homogeneity of the entire monolayer MoS₂ wafers along both orientations.

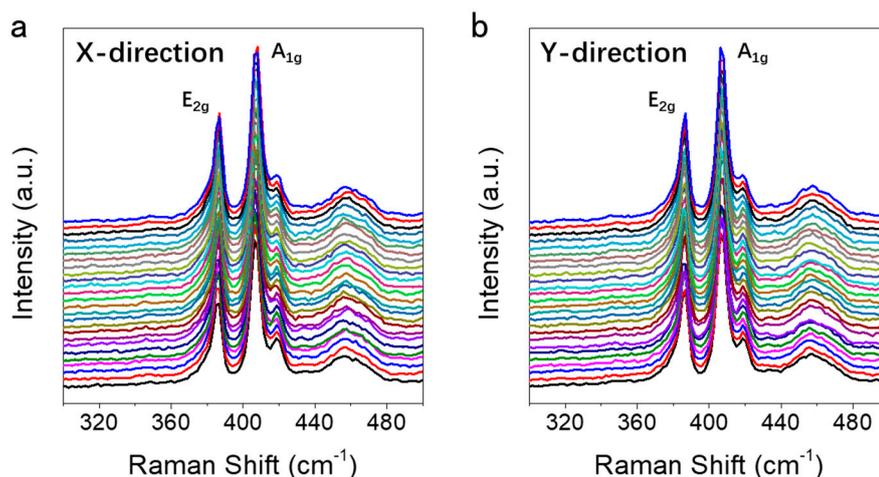


Figure S6. Raman spectra of MoS₂. (a,b) Raman spectra of wafer-scale monolayer MoS₂ along X- and Y-direction, respectively.

(7) PL spectra

Similar to the Raman spectra, we also performed PL spectra of the batch-produced MoS₂ monolayers across the entire wafer scale. Figure S7a and S7b are the normalized raw data of the PL spectra for MoS₂ monolayers along the X-direction and Y-direction. The strong PL peaks are clearly observed and show constant wavelength and intensity for the spectra in both directions, which indicate the great uniformity of monolayer MoS₂ wafers grown by batch production as well.

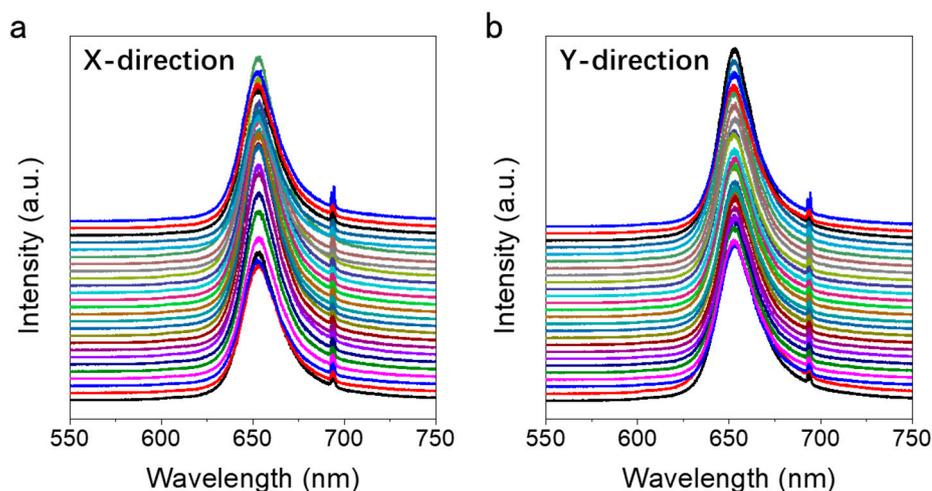


Figure S7. PL spectra of MoS₂. (a,b) PL spectra of wafer-scale monolayer MoS₂ along X- and Y-direction, respectively.

(8) Transfer characteristic curves

Back-gate FETs were fabricated on SiO₂/Si substrates to characterize the electrical performance of MoS₂ monolayers grown through batch production. Figure S8 presents the transfer characteristic curves of 20 transistors and the curves exhibit typical n-type semiconductor behavior. Field-effect mobility and current on/off ratio of these MoS₂ transistors are calculated and the average value of mobility and on/off ratio are 10.5 cm²V⁻¹s⁻¹ and 1.3×10⁶, respectively. The results of electrical performances confirm the high quality of monolayer MoS₂ produced by batch production process and the distributions of transfer curves, field-effect mobility and current on/off ratio indicate the outstanding homogeneity of MoS₂ samples.

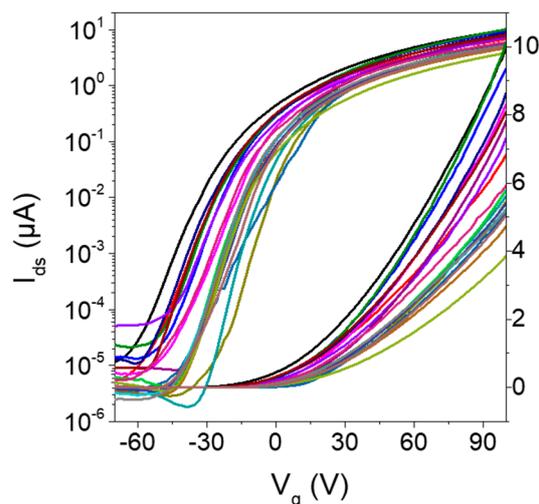


Figure S8. Transfer characteristic curves of MoS₂ FETs.

(9) Comparison of FET performance

In order to compare the performance of MoS₂ FET with previous reported results, especially the MoS₂ samples grown by chemical vapor deposition, we have meticulously compiled a comprehensive summary in Table S1. In this work, the average mobility of the MoS₂ FETs is calculated to be 10.5 cm²V⁻¹s⁻¹ and the on/off ratio averages at 1.3×10⁶, which is at a high level among the previous results. The results of electrical performance of FETs confirms the high quality of the monolayer MoS₂ films synthesized by batch production.

Table S1. Comparison of performance for MoS₂ FET.

Ref.	Field-Effect Mobility (cm ² V ⁻¹ s ⁻¹)	On/Off Ratio
Liu, L et al. [1]	3.2	1 × 10 ⁶
Liu, K et al. [2]	6	1 × 10 ⁶
Zhang, J et al. [3]	7	5 × 10 ⁶
Yang, P et al. [4]	11.2	7.7 × 10 ⁵
This work	10.5	1.3 × 10 ⁶

(10) Comparison of MoS₂ and MoS_{2-x}O_x

For purpose of comparing the contrast of intrinsic MoS₂ and oxygen doped MoS₂, photograph of original sapphire, MoS₂ and MoS_{2-x}O_x wafers is shown in Figure S9. The MoS₂ wafer show the color of olive green, while the color of MoS_{2-x}O_x wafer is yellowish brown. Although the samples present different contrasts, they show clean and homogeneous surfaces across the whole wafer, indicating the high quality of the batch-production samples.

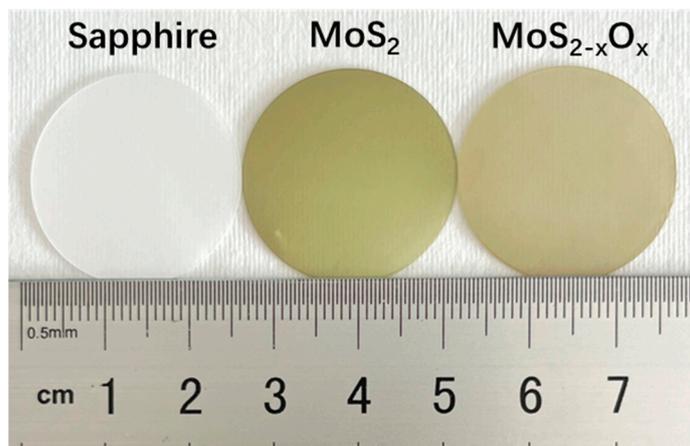


Figure S9. Comparison of monolayer MoS₂ wafer and monolayer MoS_{2-x}O_x wafer.

(11) Grain size of monolayer oxygen-doped MoS₂

The grain size of oxygen-doped MoS₂ was estimated by optical microscopy image through measuring single-crystal samples. Figure S10 shows the optical microscopy image of oxygen doped MoS₂ grain and it exhibits the grain size of around 35 μm .

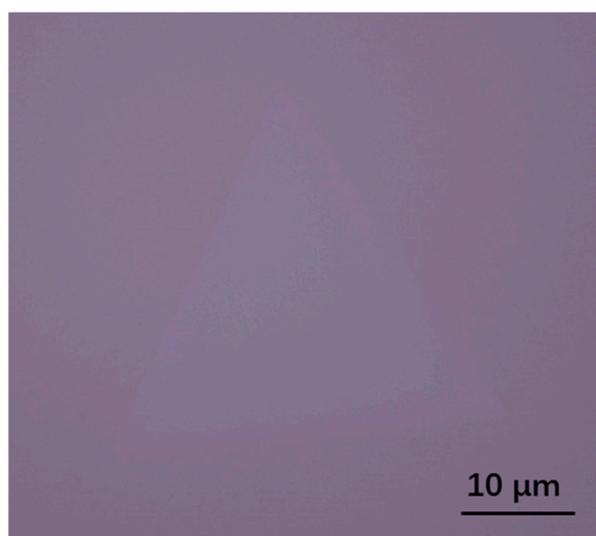


Figure S10. Estimate of the crystal grain size of MoS₂ by optical microscopy image.

References

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